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I hereby certify that this Response to the Interview Summary is being deposited on November 25, 2003 with the U.S. Postal Service as First Class Mail and is addressed to: Commissioner For Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

By: Hilary M. McNulty
Hilary M. McNulty

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

INVENTOR(S) : Francesco Lemmi, et al.

TITLE : **AMORPHOUS SILICON SENSOR WITH
MICRO-SPRING INTERCONNECTS FOR
ACHIEVING HIGH UNIFORMITY IN
INTERGRATED LIGHT-EMITTING SOURCES**

APPLICATION NO. : 09/469,122

FILED : December 21, 1999

CONFIRMATION NO. : 4551

EXAMINER : Chu, Chris C.

ART UNIT : 2815

LAST OFFICE ACTION : June 5, 2003

ATTORNEY DOCKET NO. : D/99580
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Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Response to the Interview Summary

Dear Madam/Sir:

On November 6, 2003, Applicants held a telephone interview with the Examiner. Applicants gratefully acknowledge the opportunity to discuss the application and cited references.

In the interview summary, the Examiner noted "Agreement with respect to the claims was not reached. Applicant further explained the invention and presented arguments direct[ed] to the distinction of the micro-spring interconnect tip portion and

the sensor layer[s] between the claimed invention and the references. These arguments as well as any other arguments will be fully considered when filed in response to the non-final rejection."

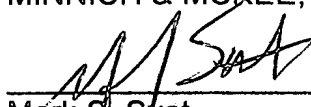
It was applicants understanding that during the interview an agreement was reached in respect to the distinction between the construction of the micro-spring interconnect claimed in present application and cited references. More particularly, the agreement was reached that in present application the interconnect includes a free portion including a tip separated from substrate which is distinguishable from Kitamura which interconnect does not include a free tip portion. Likewise, it was applicants understanding that the agreement was reached in regards to the narrowing claims describing the sensor to claim specific sensor layers with particularity. It was said that such claims would overcome Kitamura and Yamasaki.

Applicants respectfully submit that Amendment AA responding to the non-final Office Action of 06/05/03 was filed with the Patent Office on 11/05/03. Applicants would like to clarify that the Amendment AA was filed one day before the interview with the Examiner because of timing considerations. However, since the amendments and arguments of Amendment AA largely follow the discussion with the Examiner on 11/06/03, applicants do not believe that submitting a new response is essential.

In the event the Examiner considers personal contact advantageous to the disposition of this case, he/she is hereby authorized to call applicant's representative, Mark Svat, at Telephone Number (216) 861-5582.

Respectfully submitted,

FAY, SHARPE, FAGAN,
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